

# 74ALVCH16374

## Low-Voltage 16-Bit D-Type Flip-Flop with Bus Hold 1.8/2.5/3.3 V (3-State, Non-Inverting)

The 74ALVCH16374 is an advanced performance, non-inverting 16-bit D-type flip-flop. It is designed for very high-speed, very low-power operation in 1.8 V, 2.5 V or 3.3 V systems. The VCXH16374 is byte controlled, with each byte functioning identically, but independently. Each byte has separate Output Enable and Clock Pulse inputs. These control pins can be tied together for full 16-bit operation.

The 74ALVCH16374 consists of 16 edge-triggered flip-flops with individual D-type inputs and 3.6 V-tolerant 3-state outputs. The clocks (CPn) and Output Enables ( $\overline{OE}n$ ) are common to all flip-flops within the respective byte. The flip-flops will store the state of individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transition. With the  $\overline{OE}$  LOW, the contents of the flip-flops are available at the outputs. When the  $\overline{OE}$  is HIGH, the outputs go to the high impedance state. The  $\overline{OE}$  input level does not affect the operation of the flip-flops. The data inputs include active bushold circuitry, eliminating the need for external pull-up resistors to hold unused or floating inputs at a valid logic state.

- Designed for Low Voltage Operation:  $V_{CC} = 1.65 - 3.6$  V
- 3.6 V Tolerant Inputs and Outputs
- High Speed Operation: 3.6 ns max for 3.0 to 3.6 V  
4.5 ns max for 2.3 to 2.7 V  
7.8 ns max for 1.65 to 1.95 V
- Static Drive:  $\pm 24$  mA Drive at 3.0 V  
 $\pm 12$  mA Drive at 2.3 V  
 $\pm 4$  mA Drive at 1.65 V
- Supports Live Insertion and Withdrawal
- Includes Active Bushold to Hold Unused or Floating Inputs at a Valid Logic State
- $I_{OFF}$  Specification Guarantees High Impedance When  $V_{CC} = 0$  V†
- Near Zero Static Supply Current in All Three Logic States (40  $\mu$ A) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds  $\pm 250$  mA @ 125°C
- ESD Performance: Human Body Model >2000V; Machine Model >200V
- Second Source to Industry Standard 74ALVCH16374

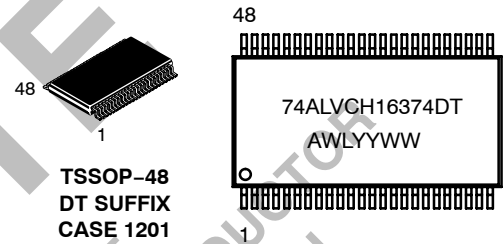
†To ensure the outputs activate in the 3-state condition, the output enable pins should be connected to  $V_{CC}$  through a pull-up resistor. The value of the resistor is determined by the current sinking capability of the output connected to the OE pin.



ON Semiconductor®

<http://onsemi.com>

### MARKING DIAGRAM



A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week

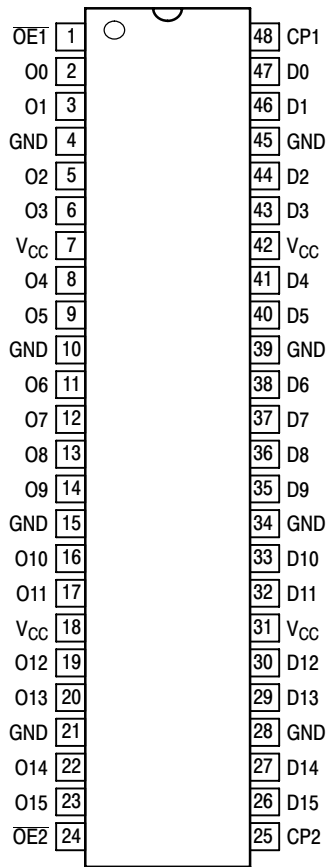
### PIN NAMES

Pins	Function
$\overline{OE}n$	Output Enable Inputs
CPn	Clock Pulse Inputs
D0-D15	Inputs
O0-O15	Outputs

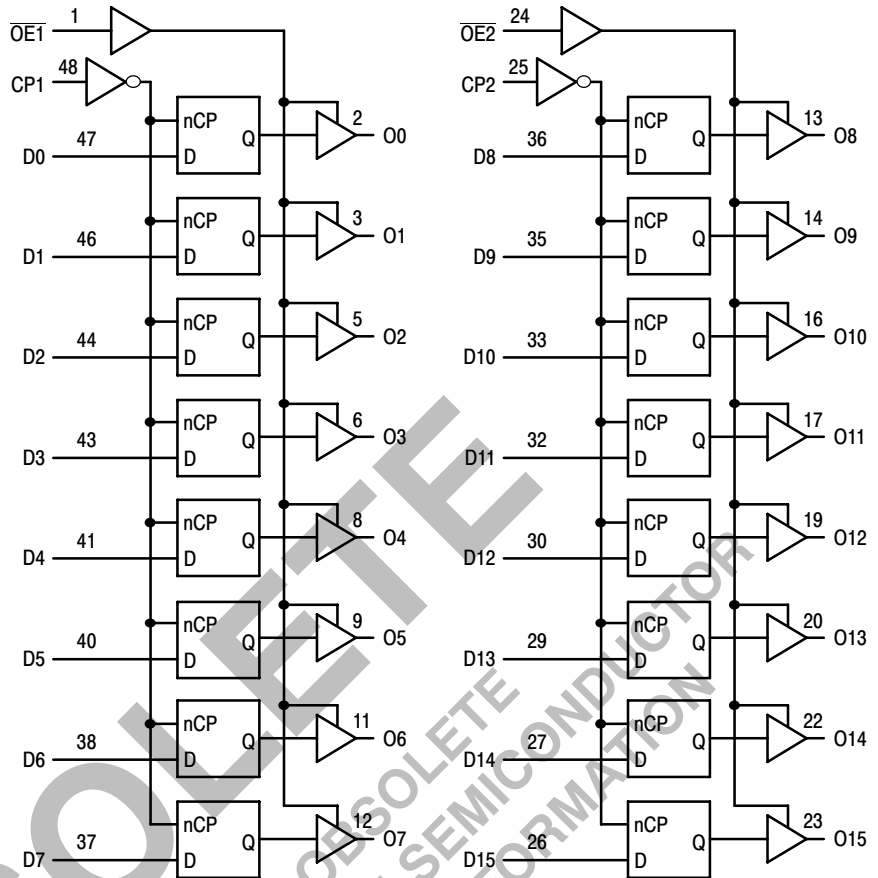
### ORDERING INFORMATION

Device	Package	Shipping
74ALVCH16374DTR	TSSOP	2500 / Reel

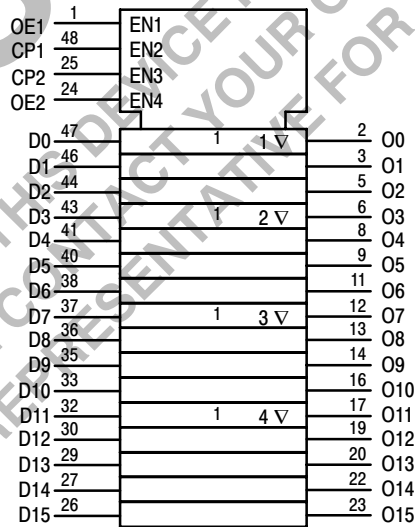
# 74ALVCH16374



**Figure 1. 48-Lead Pinout (Top View)**



**Figure 2. Logic Diagram**



**Figure 3. IEC Logic Diagram**

Inputs			Outputs	Inputs			Outputs
CP1	OE1	D0:7	O0:7	CP2	OE2	D8:15	O8:15
↑	L	H	H	↑	L	H	H
↑	L	L	L	↑	L	L	L
X	L	X	O0	X	L	X	O0
X	H	X	Z	X	H	X	Z

H = High Voltage Level; L = Low Voltage Level; Z = High Impedance State; ↑ = Low-to-High Transition; X = High or Low Voltage Level and Transitions Are Acceptable, for I<sub>CC</sub> reasons, DO NOT FLOAT Inputs. O0 = No Change.

**MAXIMUM RATINGS** (Note 1)

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage	- 0.5 to + 4.6	V
V <sub>I</sub>	DC Input Voltage	- 0.5 to + 4.6	V
V <sub>O</sub>	DC Output Voltage	- 0.5 to + 4.6	V
I <sub>IK</sub>	DC Input Diode Current V <sub>I</sub> < GND	- 50	mA
I <sub>OK</sub>	DC Output Diode Current V <sub>O</sub> < GND	- 50	mA
I <sub>O</sub>	DC Output Sink Current	± 50	mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	± 100	mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	± 100	mA
T <sub>STG</sub>	Storage Temperature Range	- 65 to + 150	°C
T <sub>L</sub>	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C
T <sub>J</sub>	Junction Temperature Under Bias	+ 150	°C
θ <sub>JA</sub>	Thermal Resistance (Note 2)	90	°C/W
MSL	Moisture Sensitivity	Level 1	
F <sub>R</sub>	Flammability Rating Oxygen Index: 30 to 35	UL 94 V-O @ 0.125 in	
V <sub>ESD</sub>	ESD Withstand Voltage Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	> 2000 > 200 N/A	V
I <sub>LATCH-UP</sub>	Latch-Up Performance Above V <sub>CC</sub> and Below GND at 125°C (Note 6)	± 250	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. I<sub>O</sub> absolute maximum rating must be observed.
2. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.
3. Tested to EIA/JESD22-A114-A.
4. Tested to EIA/JESD22-A115-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating Data Retention Only	2.3 1.5	3.6 3.6	V
V <sub>I</sub>	Input Voltage (Note 7)	-0.5	3.6	V
V <sub>O</sub>	Output Voltage (Active State) (3-State)	0 0	3.6 3.6	V
T <sub>A</sub>	Operating Free-Air Temperature	- 40	+ 85	°C
Δt/ΔV	Input Transition Rise or Fall Rate V <sub>CC</sub> = 2.5 V ± 0.2 V V <sub>CC</sub> = 3.0 V ± 0.3 V	0 0	20 10	ns/V

7. Unused inputs may not be left open. All inputs must be tied to a high-logic voltage level or a low-logic input voltage level.

## DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Condition	T <sub>A</sub> = -40°C to +85°C		Unit
			Min	Max	
V <sub>IH</sub>	HIGH Level Input Voltage (Note 8)	1.65 V ≤ V <sub>CC</sub> < 2.3 V	0.65 × V <sub>CC</sub>		V
		2.3 V ≤ V <sub>CC</sub> ≤ 2.7 V	1.7		
		2.7 V < V <sub>CC</sub> ≤ 3.6 V	2.0		
V <sub>IL</sub>	LOW Level Input Voltage (Note 8)	1.65 V ≤ V <sub>CC</sub> < 2.3 V		0.35 × V <sub>CC</sub>	V
		2.3 V ≤ V <sub>CC</sub> ≤ 2.7 V		0.7	
		2.7 V < V <sub>CC</sub> ≤ 3.6 V		0.8	
V <sub>OH</sub>	HIGH Level Output Voltage	1.65 V ≤ V <sub>CC</sub> ≤ 3.6 V; I <sub>OH</sub> = -100 μA	V <sub>CC</sub> - 0.2		V
		V <sub>CC</sub> = 1.65 V; I <sub>OH</sub> = -4 mA	1.2		
		V <sub>CC</sub> = 2.3 V; I <sub>OH</sub> = -6 mA	2.0		
		V <sub>CC</sub> = 2.3 V; I <sub>OH</sub> = -12 mA	1.7		
		V <sub>CC</sub> = 2.7 V; I <sub>OH</sub> = -12 mA	2.2		
		V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -12 mA	2.4		
		V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -24 mA	2.0		
V <sub>OL</sub>	LOW Level Output Voltage	1.65 V ≤ V <sub>CC</sub> ≤ 3.6 V; I <sub>OL</sub> = 100 μA		0.2	V
		V <sub>CC</sub> = 1.65 V; I <sub>OL</sub> = 4 mA		0.45	
		V <sub>CC</sub> = 2.3 V; I <sub>OL</sub> = 6 mA		0.4	
		V <sub>CC</sub> = 2.3 V; I <sub>OL</sub> = 12 mA		0.7	
		V <sub>CC</sub> = 2.7 V; I <sub>OL</sub> = 12 mA		0.4	
		V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 24 mA		0.55	
I <sub>I</sub>	Input Leakage Current	1.65 V ≤ V <sub>CC</sub> ≤ 3.6 V; 0 V ≤ V <sub>I</sub> ≤ 3.6 V		± 5.0	μA
I <sub>I(HOLD)</sub>	Minimum Bus-hold Input Current	V <sub>CC</sub> = 3.6 V; V <sub>IN</sub> = 0 to 3.6 V		± 500	μA
		V <sub>CC</sub> = 3.0 V, V <sub>IN</sub> = 0.8 V	75		
		V <sub>CC</sub> = 3.0 V, V <sub>IN</sub> = 2.0 V	-75		
		V <sub>CC</sub> = 2.3 V, V <sub>IN</sub> = 0.7 V	45		
		V <sub>CC</sub> = 2.3 V, V <sub>IN</sub> = 1.7 V	-45		
		V <sub>CC</sub> = 1.65 V, V <sub>IN</sub> = 0.58 V	25		
		V <sub>CC</sub> = 1.65 V, V <sub>IN</sub> = 1.07 V	-25		
I <sub>OZ</sub>	3-State Output Current	1.65 V ≤ V <sub>CC</sub> ≤ 3.6 V; 0 V ≤ V <sub>O</sub> ≤ 3.6 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>		± 10	μA
I <sub>OFF</sub>	Power-Off Leakage Current	V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 3.6 V		10	μA
I <sub>CC</sub>	Quiescent Supply Current (Note 9)	1.65 V ≤ V <sub>CC</sub> ≤ 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub>		40	μA
		1.65 V ≤ V <sub>CC</sub> ≤ 3.6 V; 3.6 V ≤ V <sub>I</sub> , V <sub>O</sub> ≤ 3.6 V		± 40	
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	2.7 V < V <sub>CC</sub> ≤ 3.6 V; V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		750	μA

8. These values of V<sub>I</sub> are used to test DC electrical characteristics only.

9. Outputs disabled or 3-state only.

# 74ALVCH16374

**AC CHARACTERISTICS** (Note 10;  $t_R = t_F = 2.0$  ns;  $C_L = 30$  pF;  $R_L = 500 \Omega$ )

Symbol	Parameter	Wave-form	Limits						Unit
			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$						
			$V_{CC} = 3.0$ V to $3.6$ V		$V_{CC} = 2.3$ V to $2.7$ V		$V_{CC} = 1.65$ V to $1.95$ V		
			Min	Max	Min	Max	Min	Max	
$f_{max}$	Clock Pulse Frequency	1	250		200		100		MHz
$t_{PLH}$ $t_{PHL}$	Propagation Delay CP to On	1	1.0 1.0	3.6 3.6	1.0 1.0	4.5 4.5	1.0 1.0	7.8 7.8	ns
$t_{PZH}$ $t_{PZL}$	Output Enable Time to High and Low Level	2	1.0 1.0	4.7 4.7	1.0 1.0	6.0 6.0	1.0 1.0	9.2 9.2	ns
$t_{PHZ}$ $t_{PLZ}$	Output Disable Time From High and Low Level	2	1.0 1.0	4.1 4.1	1.0 1.0	5.1 5.1	1.5 1.5	6.8 6.8	ns
$t_s$	Setup Time, High or Low Dn to CP	3	1.5		0.5		2.5		ns
$t_h$	Hold Time, High or Low Dn to CP	3	1.0		0.5		1.0		ns
$t_w$	CP Pulse Width, High	3	1.5		0.5		4.0		ns
$t_{OSHL}$ $t_{OSLH}$	Output-to-Output Skew (Note 11)			0.5 0.5		0.5 0.5		0.75 0.75	ns

10. For  $C_L = 50$  pF, add approximately 300 ps to the AC maximum specification.

11. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSHL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ); parameter guaranteed by design.

## CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
$C_{IN}$	Input Capacitance	Note 12	6	pF
$C_{OUT}$	Output Capacitance	Note 12	7	pF
$C_{PD}$	Power Dissipation Capacitance	Note 12, 10 MHz	20	pF

12.  $V_{CC} = 1.8, 2.5$  or  $3.3$  V;  $V_I = 0$  V or  $V_{CC}$ .

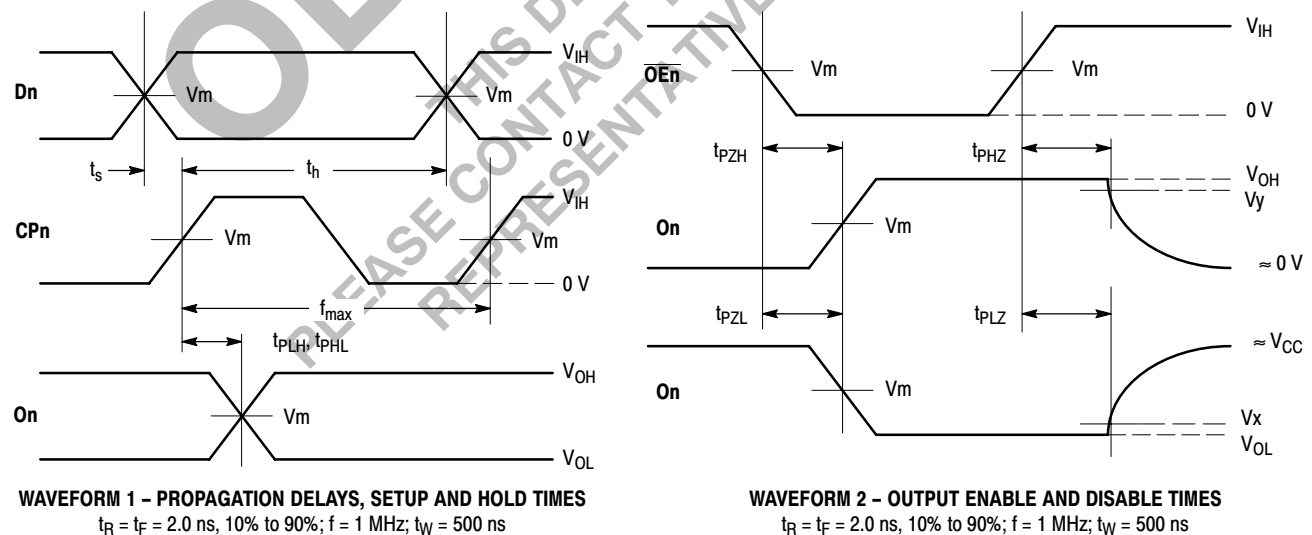
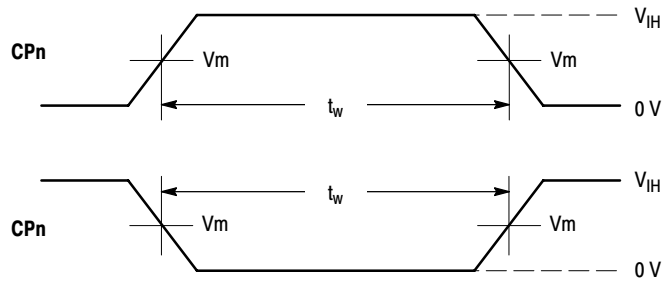


Figure 4. AC Waveforms

# 74ALVCH16374

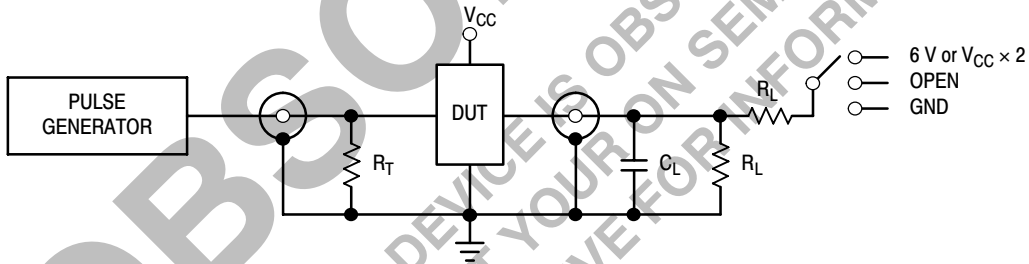


**WAVEFORM 3 - PULSE WIDTH**

$t_R = t_F = 2.0 \text{ ns}$  (or fast as required) from 10% to 90%

**Figure 5. AC Waveforms**

Symbol	$V_{CC}$		
	3.3 V $\pm 0.3$ V	2.5 V $\pm 0.2$ V	1.8 V $\pm 0.15$ V
$V_{IH}$	2.7 V	$V_{CC}$	$V_{CC}$
$V_m$	1.5 V	$V_{CC}/2$	$V_{CC}/2$
$V_x$	$V_{OL} + 0.3 \text{ V}$	$V_{OL} + 0.15 \text{ V}$	$V_{OL} + 0.15 \text{ V}$
$V_y$	$V_{OH} - 0.3 \text{ V}$	$V_{OH} - 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$



TEST	SWITCH
$t_{PLH}, t_{PHL}$	Open
$t_{PZL}, t_{PLZ}$	6 V at $V_{CC} = 3.3 \pm 0.3 \text{ V}$ ; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2 \text{ V}; 1.8 \text{ V} \pm 0.15 \text{ V}$
$t_{PZH}, t_{PHZ}$	GND

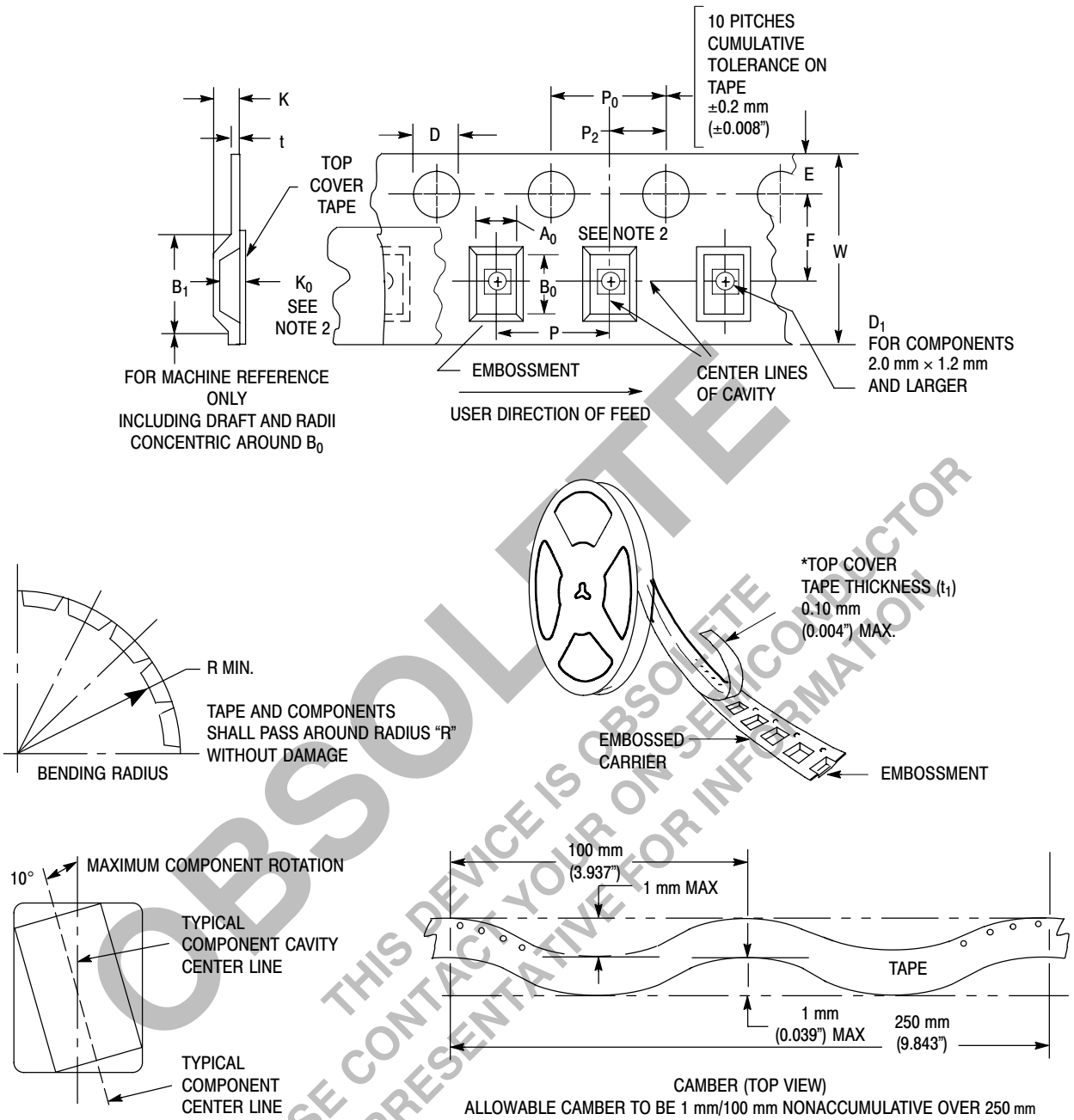
$C_L = 50 \text{ pF}$  for  $V_{CC} = 3.0 \pm 0.3 \text{ V}$

$R_L = 500 \Omega$  or equivalent

$R_T = Z_{OUT}$  of pulse generator (typically  $50 \Omega$ )

**Figure 6. Test Circuit**

# 74ALVCH16374



**Figure 7. Carrier Tape Specifications**

**EMBOSSSED CARRIER DIMENSIONS** (See Notes 1 and 2)

Tape Size	B <sub>1</sub> Max	D	D <sub>1</sub>	E	F	K	P	P <sub>0</sub>	P <sub>2</sub>	R	T	W
24mm	20.1mm (0.791")	1.5 + 0.1mm -0.0 (0.059 +0.004" -0.0)	1.5mm Min (0.060")	1.75 ±0.1 mm (0.069 ±0.004")	11.5 ±0.10 mm (0.453 ±0.004")	11.9 mm Max (0.468")	16.0 ±0.1 mm (0.63 ±0.004")	4.0 ±0.1 mm (0.157 ±0.004")	2.0 ±0.1 mm (0.079 ±0.004")	30 mm (1.18")	0.6 mm (0.024")	24.3 mm (0.957")

13. Metric Dimensions Govern—English are in parentheses for reference only.

14. A<sub>0</sub>, B<sub>0</sub>, and K<sub>0</sub> are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity.

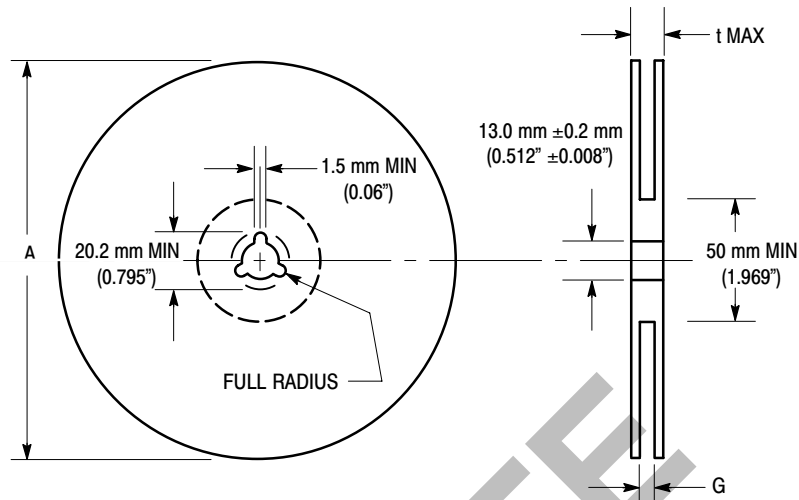


Figure 8. Reel Dimensions

REEL DIMENSIONS

Tape Size	A Max	G	t Max
24 mm	360 mm (14.173")	24.4 mm + 2.0 mm, -0.0 (0.961" + 0.078", -0.00)	30.4 mm (1.197")

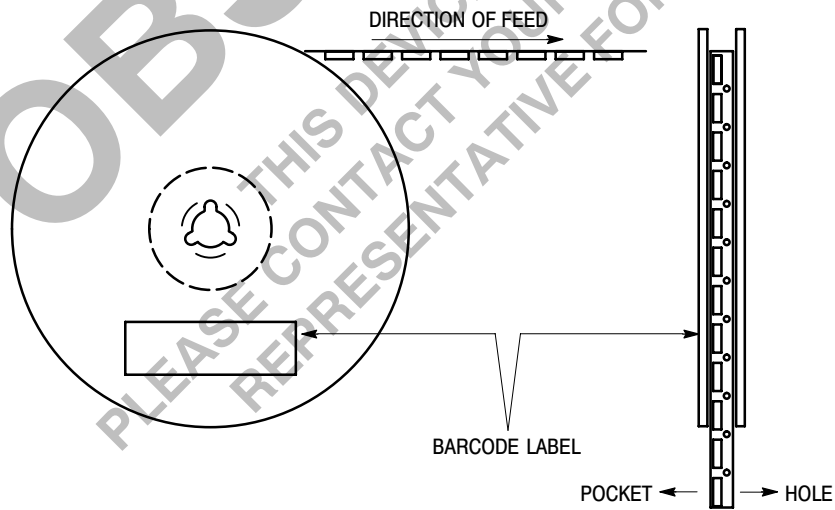


Figure 9. Reel Winding Direction



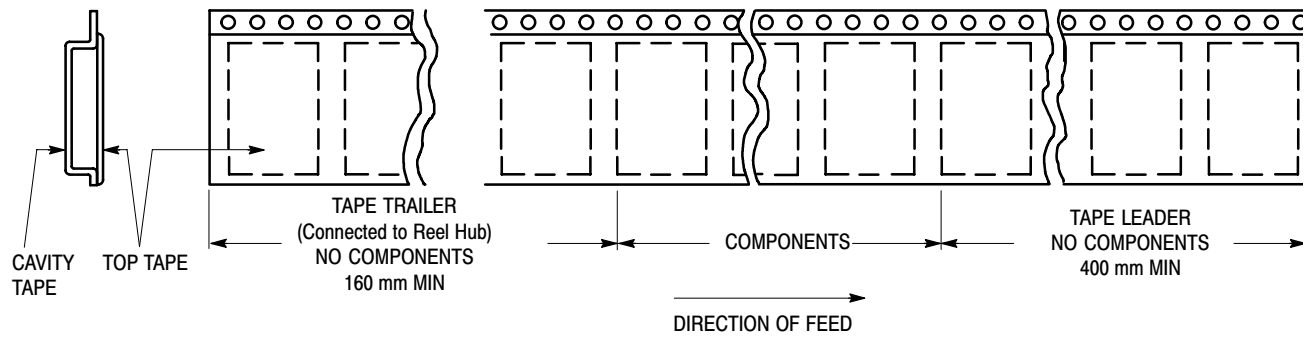


Figure 10. Tape Ends for Finished Goods

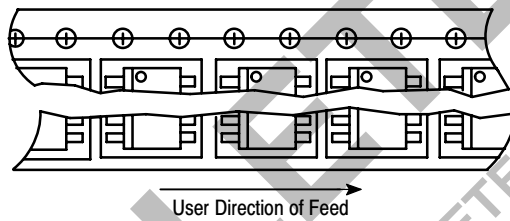


Figure 11. Reel Configuration

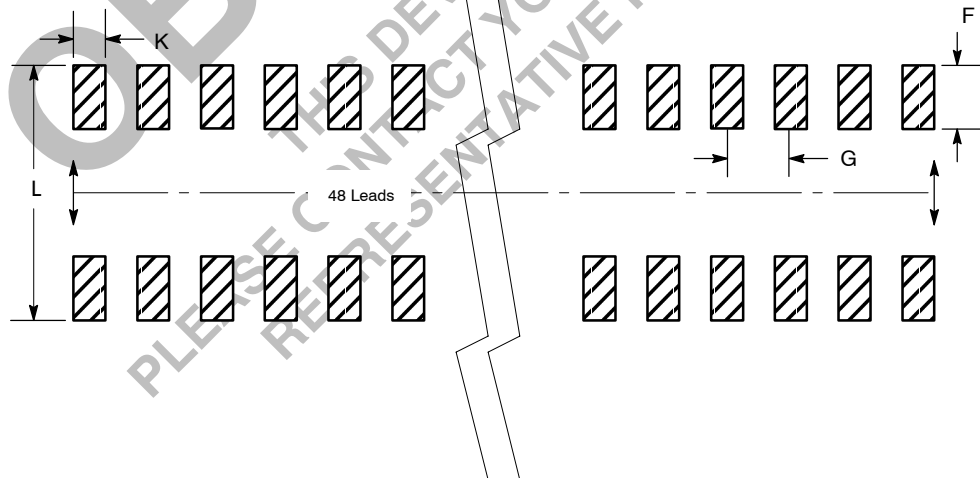
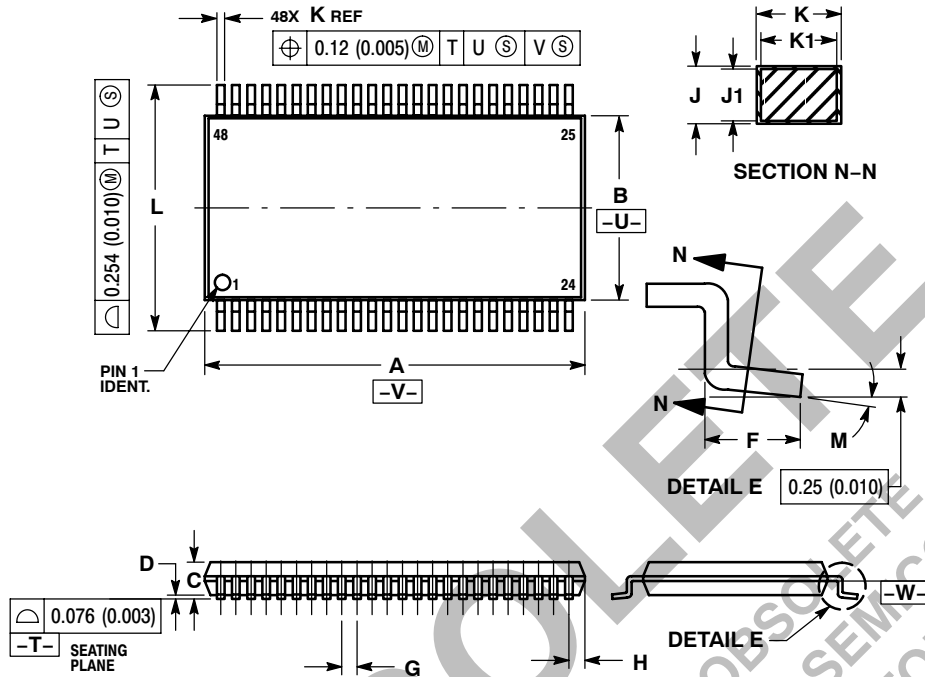


Figure 12. Package Footprint

# 74ALVCH16374

## PACKAGE DIMENSIONS

TSSOP  
DT SUFFIX  
CASE 1201-01  
ISSUE A



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.40	12.60	0.488	0.496
B	6.00	6.20	0.236	0.244
C	---	1.10	---	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC		0.0197 BSC	
H	0.37	---	0.015	---
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0°	8°	0°	8°

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT:**  
Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: orderlit@onsemi.com

**N. American Technical Support:** 800-282-9855 Toll Free USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5773-3850

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local Sales Representative

74ALVCH16374/D